

General Description

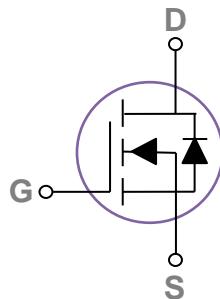
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
40V	7.2mΩ	45A

Features

- 40V,45A, RDS(ON) =7.2mΩ @VGS = 10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

PPAK3X3 Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	40	V
V _{Gs}	Gate-Source Voltage	+20/-12	V
I _D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	45	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	28	A
I _{DM}	Drain Current – Pulsed ¹	180	A
EAS	Single Pulse Avalanche Energy ²	65	mJ
IAS	Single Pulse Avalanche Current ²	36	A
P _D	Power Dissipation ($T_c=25^\circ\text{C}$)	33	W
	Power Dissipation – Derate above 25°C	0.26	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	3.84	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250µA	40	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =40V, V _{GS} =0V, T _J =25°C	---	---	1	µA
		V _{DS} =32V, V _{GS} =0V, T _J =100°C	---	---	10	µA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =20V, V _{DS} =0V	---	---	100	nA

On Characteristics

R _{DSON}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =8A	---	6	7.2	mΩ
		V _{GS} =4.5V, I _D =6A	---	9.6	12.5	mΩ
V _{Gsth}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250µA	1.2	1.6	2.5	V
gfs	Forward Transconductance	V _{DS} =10V, I _S =1A	---	5	---	S

Dynamic and switching Characteristics

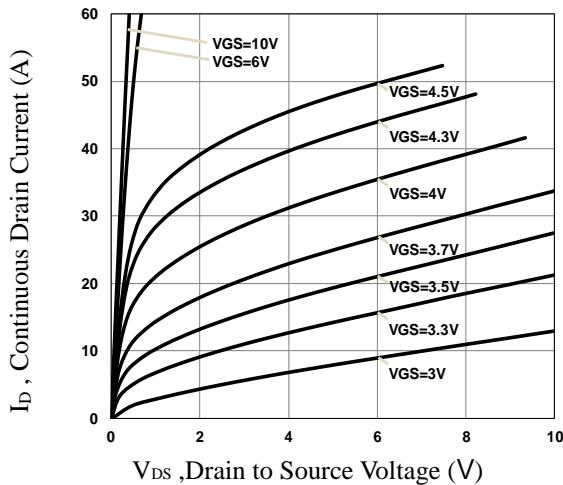
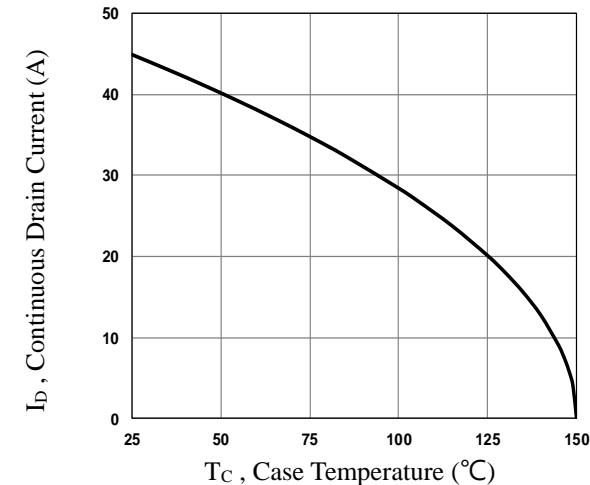
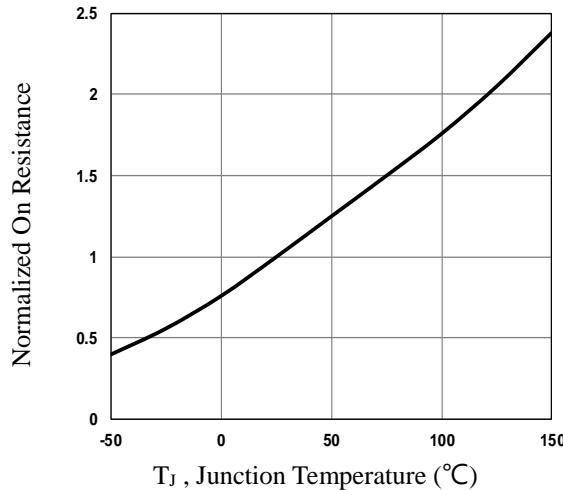
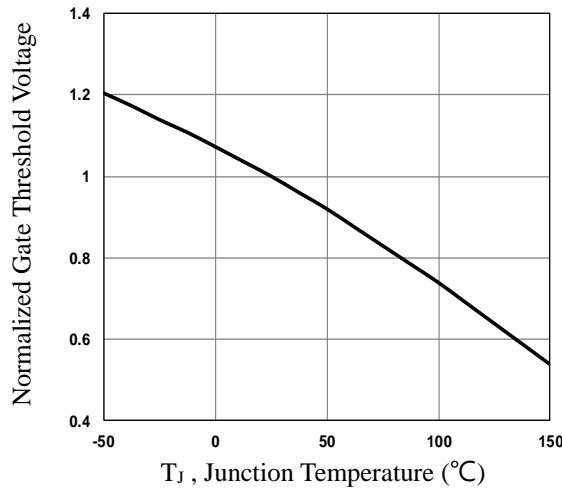
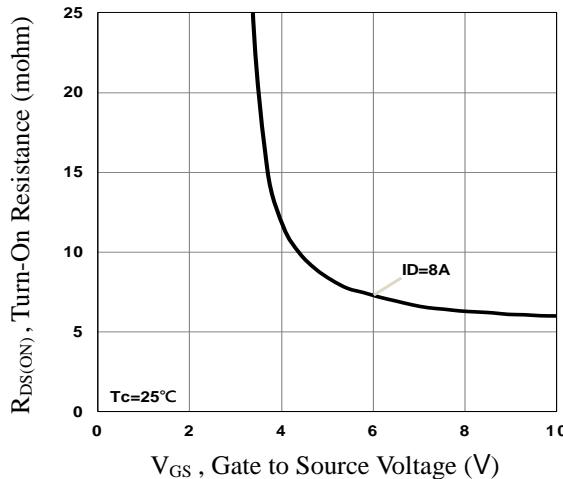
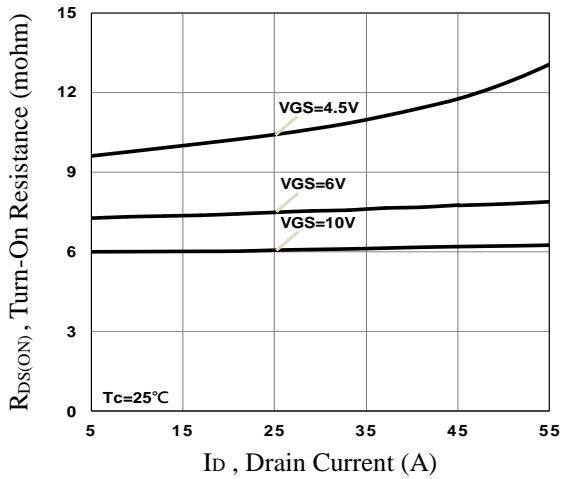
Q _g	Total Gate Charge ^{3, 4}	V _{DS} =20V, V _{GS} =10V, I _D =25A	---	13.7	20	nC
Q _{gs}	Gate-Source Charge ^{3, 4}		---	2.2	5	
Q _{gd}	Gate-Drain Charge ^{3, 4}		---	3.7	7	
T _{d(on)}	Turn-On Delay Time ^{3, 4}	V _{DD} =20V, V _{GS} =10V, R _G =6Ω I _D =25A	---	10	15	ns
T _r	Rise Time ^{3, 4}		---	14	21	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}		---	28	42	
T _f	Fall Time ^{3, 4}		---	20	30	
C _{iss}	Input Capacitance	V _{DS} =20V, V _{GS} =0V, F=1MHz	---	930	1400	pF
C _{oss}	Output Capacitance		---	380	570	
C _{rss}	Reverse Transfer Capacitance		---	30	45	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1	---	Ω

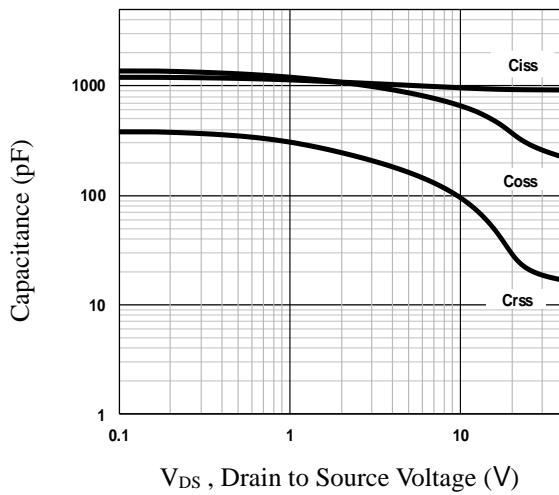
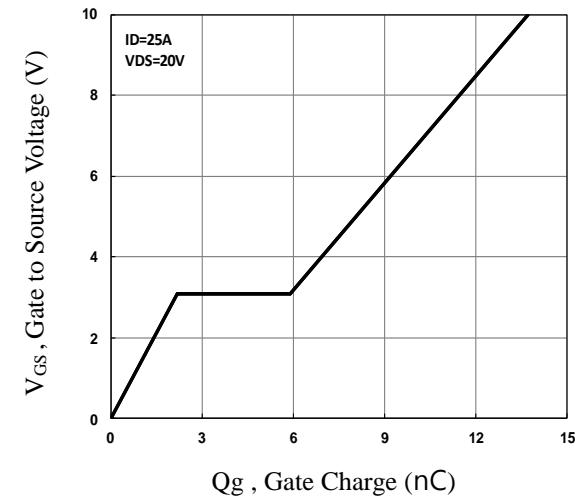
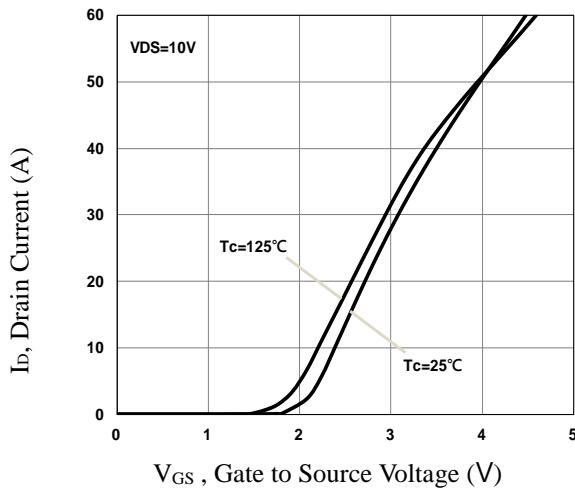
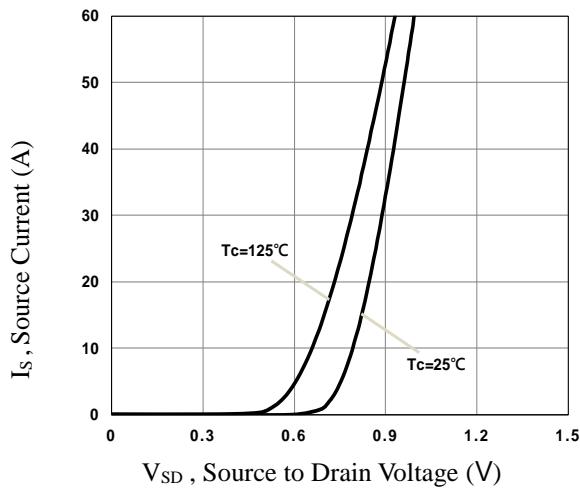
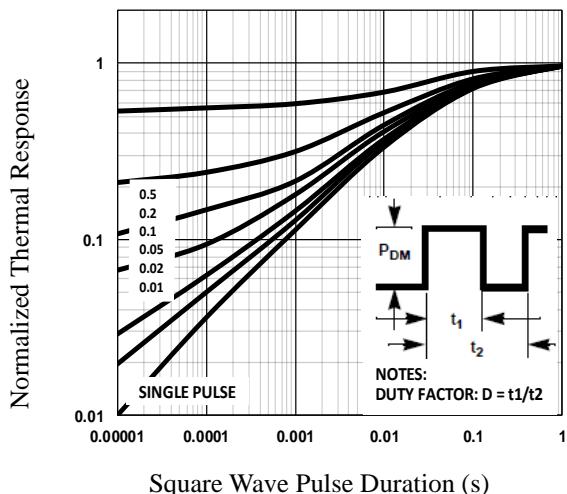
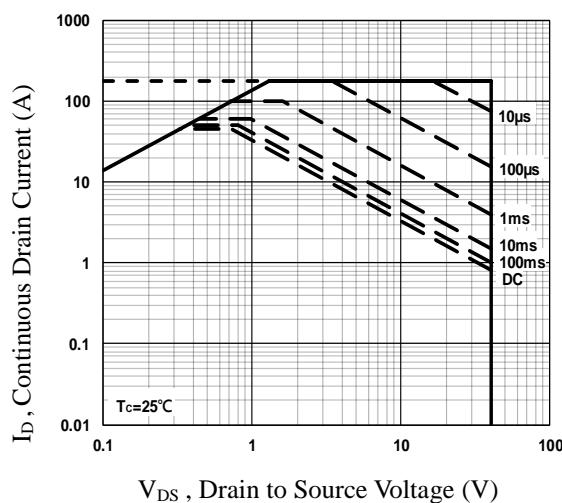
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _s	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	45	A
I _{SM}	Pulsed Source Current		---	---	90	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _s =1A, T _J =25°C	---	---	1	V
T _{rr}	Reverse Recovery Time	V _R =30V, I _s =10A	---	45	---	ns
Q _{rr}	Reverse Recovery Charge	di/dt=100A/µs T _J =25°C	---	35	---	nC

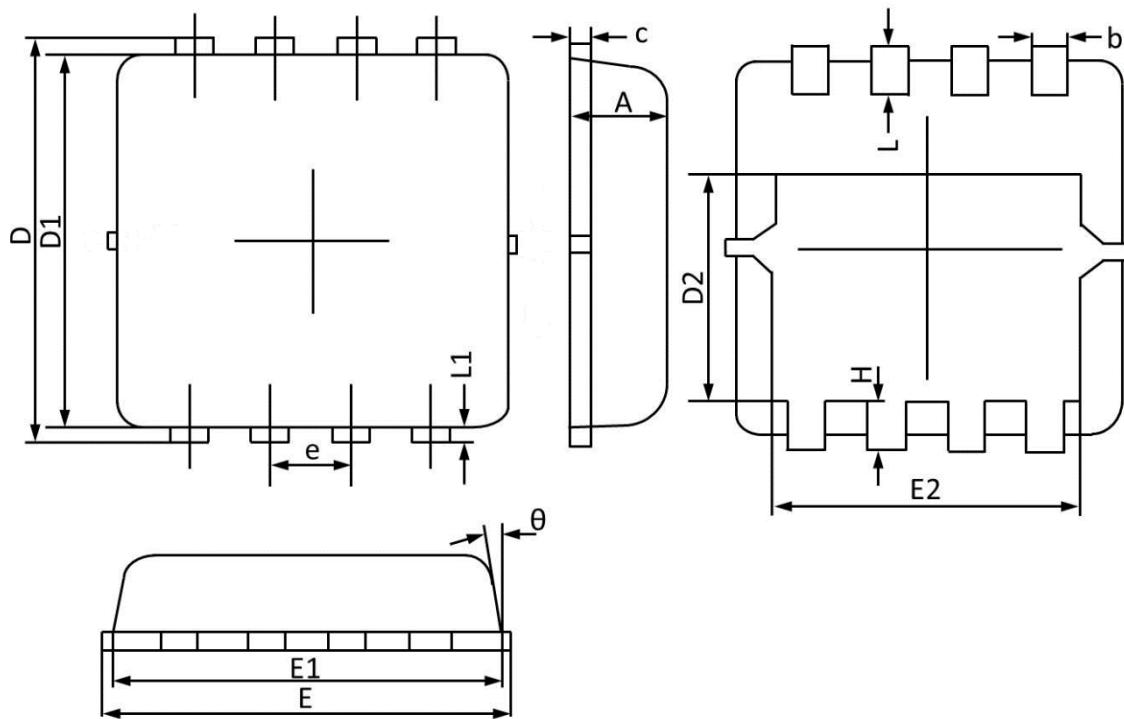
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=36A., R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed, pulse width ≤ 300µs, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.


Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized R_{DSON} vs. T_j

Fig.4 Normalized V_{th} vs. T_j

Fig.5 Turn-On Resistance vs. V_{GS}

Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Transfer Characteristics

Fig.10 Source Current vs. V_{SD}

Fig.11 Normalized Transient Impedance

Fig.12 Maximum Safe Operation Area

PPAK3x3 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	0.900	0.700	0.035	0.028
b	0.350	0.250	0.014	0.010
c	0.250	0.100	0.010	0.004
D	3.500	3.050	0.138	0.120
D1	3.200	2.900	0.126	0.114
D2	1.950	1.350	0.077	0.053
E	3.400	3.000	0.134	0.118
E1	3.300	2.900	0.130	0.114
E2	2.600	2.350	0.102	0.093
e	0.65BSC		0.026BSC	
H	0.750	0.300	0.030	0.012
L	0.600	0.300	0.024	0.012
L1	0.200	0.060	0.008	0.002
θ	14°	6°	14°	6°

PPAK3X3 RECOMMENDED LAND PATTERN